

List of Publications by Year in descending order

Source: https://exaly.com/author-pdf/1618629/publications.pdf Version: 2024-02-01



IF # ARTICLE CITATIONS Experimental studies on a high performance compact loop heat pipe with a square flat evaporator. Applied Thermal Engineering, 2010, 30, 741-752. Geometric optimization of a micro heat sink with liquid flow. IEEE Transactions on Components and 9 1.3112 Packaging Technologies, 2006, 29, 145-154. Power-saving exploration for high-end ultra-slim laptop computers with miniature loop heat pipe 10.1 84 cooling module. Applied Energy, 2019, 239, 859-875. An ultra-thin miniature loop heat pipe cooler for mobile electronics. Applied Thermal Engineering, 4 6.0 83 2016, 109, 514-523. Mechanism of a microscale flat plate heat pipe with extremely high nominal thermal conductivity for 9.2 cooling high-end smartphone chips. Energy Conversion and Management, 2019, 201, 112202. 3D heat transfer analysis in a loop heat pipe evaporator with a fully saturated wick. International Journal of Heat and Mass Transfer, 2011, 54, 564-574. 4.8 63 6 A new cooling strategy for edge computing servers using compact looped heat pipe. Applied Thermal 6.0 53 Engineering, 2021, 187, 116599. High Power Electronic Component: Review. Recent Patents on Engineering, 2008, 2, 174-188. 8 0.4 37 A Compact Loop Heat Pipe With Flat Square Evaporator for High Power Chip Cooling. IEEE 2.5 34 Transactions on Components, Packaging and Manufacturing Technology, 2011, 1, 519-527. A robust pulsating heat pipe cooler for integrated high power LED chips. Heat and Mass Transfer, 2017, 10 2.1 32 53, 3305-3313. A thermosyphon heat pipe cooler for high power LEDs cooling. Heat and Mass Transfer, 2016, 52, 1541-1548. Characteristics of thermal storage heat pipe charged with graphene nanoplatelets enhanced organic 12 9.2 24 phase change material. Energy Conversion and Management, 2022, 267, 115902. Directly air-cooled compact looped heat pipe module for high power servers with extremely low 10.1 power usage effectiveness. Applied Energy, 2022, 319, 119279. Comparative studies of pool boiling heat transfer with nano-fluids on porous surface. Heat and Mass 14 2.115 Transfer, 2015, 51, 1769-1777. Comparative Study on Thermal Performance of Ultrathin Miniature Loop Heat Pipes With Different 2.1 Internal Wicks. Journal of Heat Transfer, 2017, 139, . Pumping power and heating area dependence of thermal resistance for a large-scale microchannel 16 2.1 9 heat sink under extremely high heat flux. Heat and Mass Transfer, 0, , 1. Transient thermodynamic response and boiling heat transfer limit of dielectric liquids in a two-phase 2.7 closed direct immersion cooling system. Thermal Science and Engineering Progress, 2021, 25, 100986. 3D Heat Transfer Analysis of a Miniature Copper-Water Vapor Chamber with Wicked Pillars Array. ISRN 18 0.9 6

Mechanical Engineering, 2013, 2013, 1-10.